SPECIFICATION FOR APPROVAL

DESCRIPTION: Pitch 0.80mm Board	To Board Connector, V/T, SMT Type male Post	
CUSTOMER PROD.NO/DWG.NO:		
E&T PROD.NO:	1133K-XXXX-XXX	
APPROVAL SHEET NO:		
E&T DWG. NO./DOCUMENT:	1133K-XXXX-XXX	
		DEV: A2

PLEASE RETURN TO US ONE COPY OF "SPECIFICATION FOR APPROVAL" WITH YOUR APPROVED SIGNATURES.

APPROVED SIGNATURES							



ENTERY INDUSTRIAL CO., LTD.
E&T ELECTRONICS (DONG GUAN) CO., LTD.
E&T ELECTRONICS (SU ZHOU) CO., LTD.
E&T ELECTRONICS (NANKEEN)CO.,LTD.

Title :Pitch 0.80mm Board To Board Connector, V/T, SMT Type male Post

RELEASE HISTORY Title: Pitch 0.80mm Board To Board Connector, V/T, SMT Type male Po					
A2	06,01,2012'	This Document Contains Information That Is Proprietary To			
Rev	Description	E&T And Should Not Be Used Without Written Permission			
Document No.			Prepared By: Hill Chang	Date: 01,08'2009	
		X-XXX	Checked By:	Date: 06 07 70/2'	
		IN INIMIM	Approved By:	Date:	

GROUP AND TEST SEQUENCE

	Test of Examination		Test Group									
			В	C	D	Е	F	G	Н	I	J	K
1	Examination of Product	1,9	1,6	1,5	1,5	1,5	1,4	1,5	1,3	1,3	1,5	
2	Contact Resistance	2,6	2,5	2,4	2,4	2,4		2,4			2,4	
3	Insulation Resistance	3,7										
4	Dielectric Strength	4,8										
5	Insertion Force And Withdrawal Force		3									
6	Terminal / Housing Retention Force											1
7	Durability		4									
8	Vibration			3								
9	Heat Resistance				3							
10	Cold Resistance					3						
11	Humidity	5										
12	Solder Ability						3		2			
13	Resistance To Soldering Heat									2		
14	Steam Aging						2					
15	Salt Spray							3				
16	Temperature Cycling										3	

PRODUCT SPECIFICATION

1. SCOPE:

This specification covers the 0.8 mm pitch board To board SMT type connector series.

2. PRODUCT NAME AND PART NUMBER:

Product Name	E&T Part Number
0.80mm Board To Board Connector, V/T, SMT Type male Post(Lead Free)	1133K-XXXX-XXX

3. RATINGS:

Item	S	tandard
Rated Voltage (MAX.)	50 V	AC
Rated Current (MAX.)	1A	χ.
Ambient Temperature Range	-40 ⁰	C ~ +85 ⁰ C

^{*}Including terminal temperature rise

4.PERFORMANCE:

4-1 Electrical Performance

Item		Test Condition	Requirement	
4-1-1	Contact Resistance	Test Current: 100 mA Max. Test Voltage: 20mV Max Test Method: MIL-STD-202F, Method 303	50 mΩ MAX.	
4-1-2 Insulation		Test Voltage: 100VAC. Test Duration: 1 minutes.	Initial: 500 MΩ Min	
	Resistance	Test Method: MIL-STD-202, method 302	Final: 100 M Ω Min.	
4-1-3	Dielectric Strength	Test Voltage: 200V AC. Test Time: 60 sec. Test Method: MIL-STD-202, Method 301.	No Breakdown	

4-2 Mechanical Performance

	Item	Test Condition	Requirement	
4-2-1	Insertion Force And Withdrawal Force	Test Speed: 25±3 mm/min. Test Method: MIL-STD-1344A, Method 2016.	Insertion Force Max: 0.09kgf X total terminals Withdrawal Force(Min): 0.01kgf X total terminals	
4-2-3	Terminal / Housing Retention Force	Test Speed: 25mm/min.	0.5kgf (Min)	

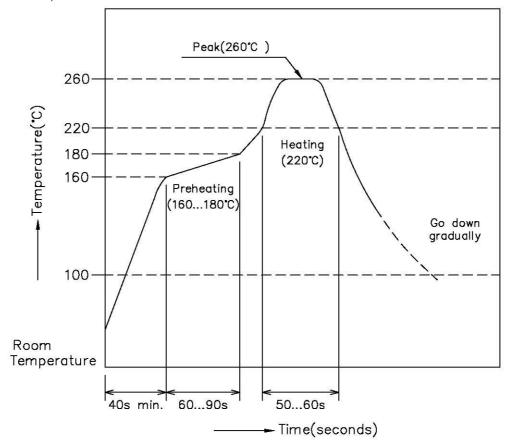
4-3 Environmental Performance and Others

Item Test C		Test Condition	Requirement		
		The contacts of connector shall be subject to 50 cycles of mating and unmating.	Contact Re	sistance	
4-3-1	Durability	oyoloo or mating and arimating.	Initial Value	\leq 50 m Ω	
			Final Value	\leq 70 m Ω	
		Amplitude: 1.5 mm Frequency range: 10~55~10 Hz in 1 minute	Appearance	No Damage	
4-3-2	Vibration	Duration: 2 hours in each X.Y.Z axes Current: 100mA. Test Method: MIL-STD-202F, Method 201	Contact Resistance	\leq 70 m Ω	
		Test Method: MIL-31D-2021, Method 201	Discontinuity	1µsec	
4-3-4	Heat Resistance	Temperature: $85\pm2^{\circ}$ C Duration: 96 hours	Appearance	No Damage	
7-0-4		Test Method: MIL-STD-202, Method 108.	Contact Resistance	\leq 70 m Ω	
4-3-5 Cold		Temperature: -40±2°C Duration: 96 hours Test Method: JIS C60068-2-1	Appearance	No Damage	
4-5-5	Resistance	Test Method. 313 Coodoo-2-1	Contact Resistance	\leq 70 m Ω	
		Temperature: 40±2℃ Relative Humidity: 90~95%	Appearance	No Damage	
4-3-6	Humidity	Duration: 96 hours Test Method: MIL-STD-202F , Method 103	Contact Resistance	\leq 70 m Ω	
	riumunty		Insulation Resistance	\geq 100M Ω	
			Dielectric Strength	Must meet 4-1-3	

	Item	Test Condition	Requi	rement
4-3-7	Solder Ability	Soldering Time : 3 ± 0.5 sec Solder Temperature : $245\pm5^{\circ}$ C Test Method: MIL-STD-202F , Method 208	Solder Wetting	95% Of Immersed Area Must Show No Voids, Pin Holes
4-3-8	Resistance To Soldering Heat	Soldering Time : 10 ± 0.5 sec Solder Temperature : $260\pm5^{\circ}$ C Test Method: MIL-STD-202F , Method 210A	Appearance	No Damage
		Steam Aging Temperature : 98±2°C Duration: 8 hours Solder Temperature : 245±5°C	Appearance	No Damage
4-3-9	Steam Aging	Soldering Time: 3±0.5 sec Test Method: MIL-STD-202F, Method 208	Solder Wetting	95% Of Immersed Area Must Show No Voids, Pin Holes
4-3-10	Salt Spray	Chamber Temperature : 35±2°C Air Tank Temperature : 47±1°C Salt Solution : 5 ± 0.5% Duration : 48 hours	Appearance	No Damage
	Test Method: MIL-STD-202, Method 1		Contact Resistance	\leq 70 m Ω
4-3-11	Temperature	5 cycles of : a) - 55 $\pm 3^{\circ}$ C 30 minutes b) +25 $\pm 3^{\circ}$ C 30 minutes	Appearance	No Damage
4-3-11	Cycling	c)+ 85 $\pm 2^{\circ}$ C 30 minutes Test Method: JIS C0025	Contact Resistance	\leq 70 m Ω

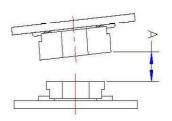
INFRARED REFLOW CONDITION

- 1) Ascending time to preheating temperature 170°C shall be 40 seconds minimum.
- 2) Preheating shall be fixed at 160...180°C for 60...90 seconds.
- 3) Heating shall be fixed at 220°C for 50...60 seconds.
- 4) At 260±5°C peak shall be 10 seconds maximum.



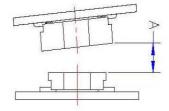
Precaution in the connector handing.

1. Please try that the connector parallel is mated is mated Into or unmated form the counterpart connector in parallel.

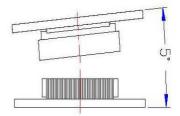


2. Mating (into the counterpart connector)
At the time of mating please do not continue to mate the connector if there is the gap.

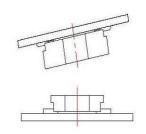
A to the one side, please mate the connectors when the both guides are guided.



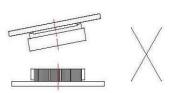
When mating plug with receptacle obliquely ,please make mating within an angle of 5°.



3. Unmating (from the counterpart connector)
Please do not extract the one side of the printed circuit board.
Please extract the printed curcuit board in parallel with the connector.



4. Please do not bend the printed circuit board in the arrow direction.



5. After mating connectors, fix the PCB/PWB in order not for them to disengage.

RELEASE HISTORY

Rev.	Revisions	Date	Executor	Description
A2	RE201205010	JUN-01-2012	JIMMY	MATERIAL CHANGE